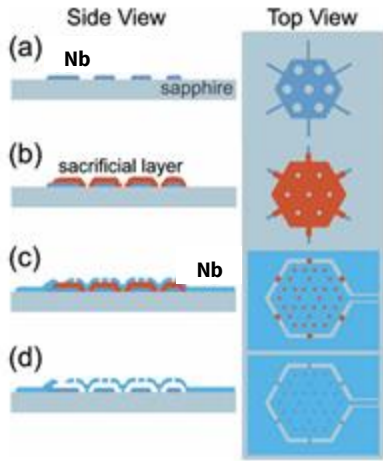


# Superconducting Parallel Plate Capacitors with High Kinetic Inductance



Poster Presentation

Kevin Multani  
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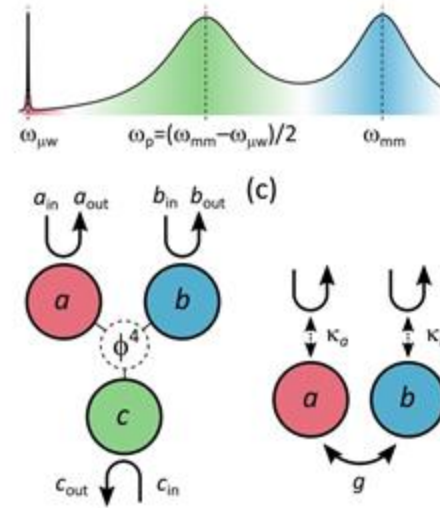
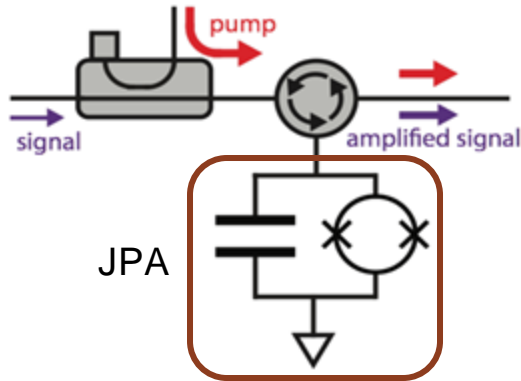
**Mentors:**

Swaroop Kommera  
Don Gardner  
Usha Raghuram



# Motivation:

- **Microwave to mm-wave transducers<sup>1</sup>** for near lossless transmission between dilution refrigerators as a stepping stone for scalable Quantum Networks



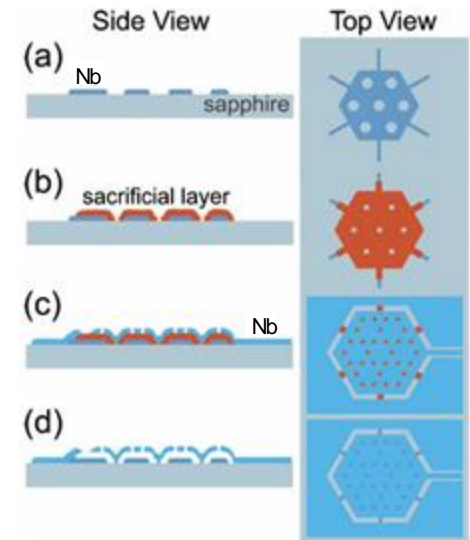
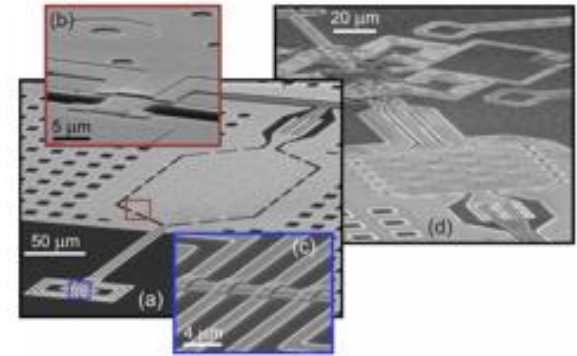
- **Josephson Parametric Amplifiers (JPAs)** for studying quantum jumps, generation, and detection of the squeezed microwave field, quantum feedback, real-time tracking of qubit state evolution and quantum error detection<sup>2</sup>

[1] M. Pechal, A. Safavi-Naeini, *Phys. Rev. A.*, 96 (2017)

[2] Tanay Roy et al., *Appl. Phys. Lett.* 107, 262601 (2015)

# Project Goals:

- We propose the fabrication of the **parallel-plate capacitors** analogous to the process in the study of K. Cicak et al. using Aluminum structures<sup>3</sup>. We are using **Niobium** instead (high kinetic inductance material)
- Designing **5 GHz resonators** with a large capacitance achievable with parallel-plate capacitors compatible with a superconducting device coupled to mm-waves<sup>4</sup>



[3] K. Cicak et al., *Appl. Phys. Lett.* 96 (2010)

[4] H. Stokowski et al. *IRMMW-THz 2019*, Paris, 1-6 Sep. 2019

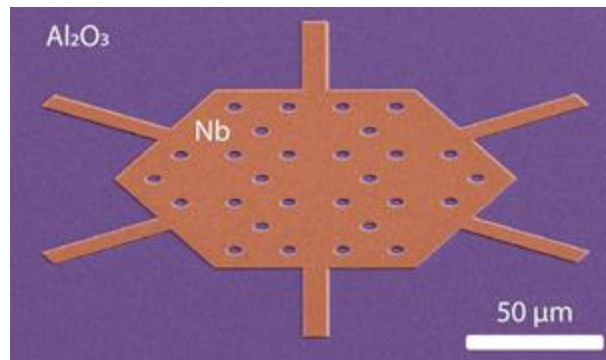
## Benefits to SNF:

### Fall Quarter:

- Characterization of **selective Nb etching** in  $\text{CF}_4$  plasma – 3 parameters DOE
- Characterization of **selective  $\text{SiO}_2$  etching** in  $\text{CF}_4:\text{CHF}_3$  plasma – 3 parameters DOE
- Characterization of lesker-sputterer in the context of **Nb Deposition**
- **Evaporation** of good-quality Niobium films

### Winter Quarter:

- Process flow for **vapor HF** etching of the  $\text{SiO}_2$  and releasing Nb structures:
  - Air Bridges for Spiral Inductors
  - Parallel Plate Capacitors
- Process for creating **vias** to galvanically connect two planes

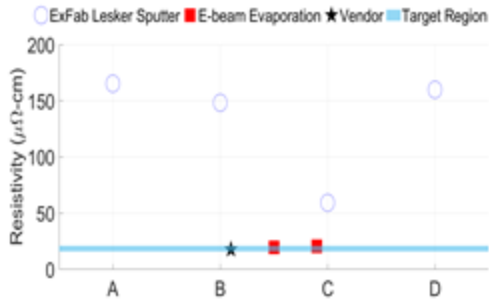


# Highlights of the Fall Quarter:

Total Expenditure: \$5632.01

## Nb deposition

Lesker Sputtering system deposits films with inadequate electrical properties. We will characterize the new Lesker and explore Nb evaporation, which has shown favorable results so far.

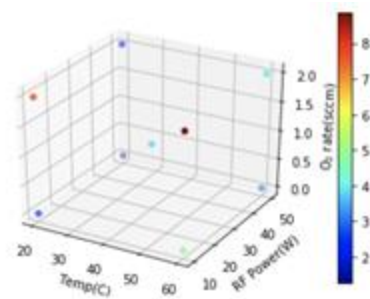


## Selective Nb etching

3-point DOE finished, selectivity to  $\text{SiO}_2 \sim 9$  achieved.

Main factors identified:

- RF Bias power
- Chamber Pressure

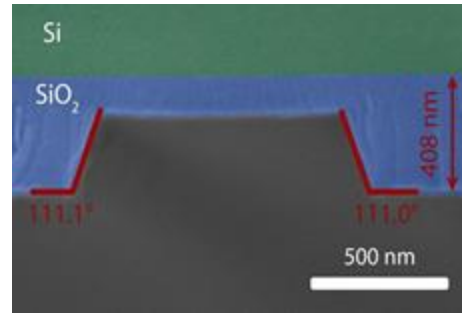


## $\text{SiO}_2$ deposition and patterning

3-point DOE done in  $\text{CF}_4/\text{CHF}_3$  plasma. Selectivity to Nb  $\sim 10$  achieved.

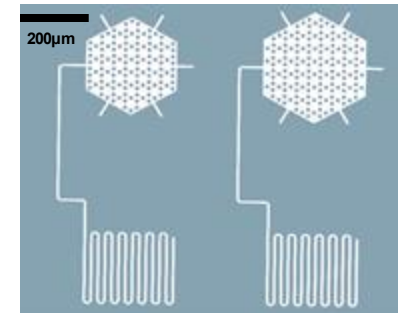
Main factor identified:

- $\text{CHF}_3$  content (quadratic)



## Nb meander inductor

Meander inductors patterned with Nb on sapphire platform



**Thank you!**  
**See you at the poster**